Features

- Serial EEPROM Family for Configuring Altera FLEX[®] Devices
- Simple Interface to SRAM FPGAs
- EE Programmable 2M-bit Serial Memories Designed to Store Configuration Programs for Field Programmable Gate Arrays (FPGAs)
- Cascadable Read Back to Support Additional Configurations or Future Higher-density Arrays
- Low-power CMOS EEPROM Process
- Programmable Reset Polarity
- Available in the Space-efficient Surface-mount PLCC Package
- In-System Programmable Via 2-wire Bus
- Emulation of Atmel's AT24CXXX Serial EEPROMs
- Available in 3.3V ± 5% LV and 5V ± 5% C Versions
- System-friendly READY Pin

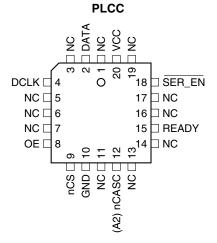
Description

The AT17C020A and AT17LV020A (high-density AT17A Series) FPGA Configuration EEPROMs (Configurators) provide an easy-to-use, cost-effective configuration memory for programming Altera FLEX® devices. The AT17A Series is packaged in the popular 20-lead PLCC. The AT17A Series family uses a simple serial-access procedure to configure one or more FPGA devices. The AT17A Series organization supplies enough memory to configure one or multiple smaller FPGAs. Using a feature of the AT17A Series, the user can select the polarity of the reset function by programming internal EEPROM bytes. The AT17A parts generate their own internal clock and can be used as a system "master" for loading the FPGA devices.

The Atmel devices also support a system-friendly READY pin. The READY pin is used to simplify system power-up considerations.

The AT17A Series Configurators can be programmed with industry-standard programmers, or Atmel's ATDH2200E Programming Kit.

Pin Configurations





FPGA Configuration EEPROM Memory

2-Mbit

Altera Pinout

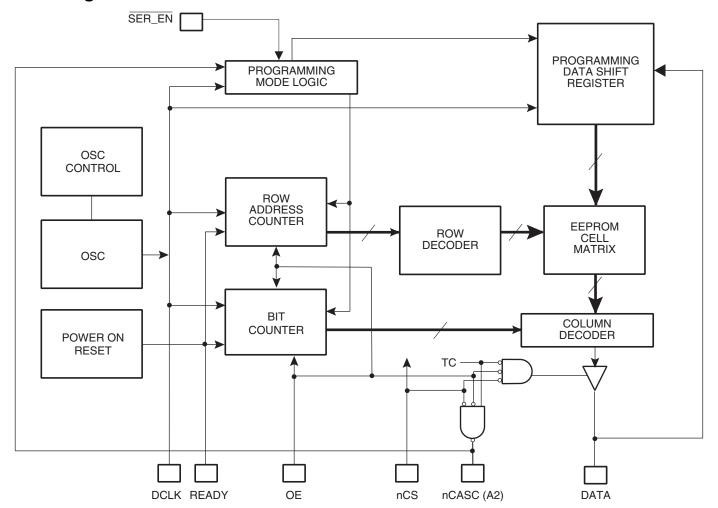
AT17C020A AT17LV020A







Block Diagram



Device Configuration

The control signals for the configuration EEPROM-nCS, OE, and DCLK-interface directly with the FPGA device control signals. All FPGA devices can control the entire configuration process and retrieve data from the configuration EEPROM without requiring an external intelligent controller.

The configuration EEPROM's OE and nCS pins control the tri-state buffer on the DATA output pin and enable the address counter and the oscillator. When OE is driven Low, the configuration EEPROM resets its address counter and tri-states its DATA pin. The nCS pin also controls the output of the AT17A Series Configurator. If nCS is held High after the OE reset pulse, the counter is disabled and the DATA output pin is tri-stated. When nCS is driven Low, the counter and the DATA output pin are enabled. When OE is

driven Low again, the address counter is reset and the DATA output pin is tri-stated, regardless of the state of the nCS.

When the Configurator has driven out all of its data and nCASC is driven Low, the device tri-states the DATA pin to avoid contention with other Configurators. Upon power-up, the address counter is automatically reset.

The READY pin is available as an open-collector indicator of the device's reset status; it is driven Low while the device is in its power-on reset cycle and released (tri-stated) when the cycle is complete.

This document discusses the EPF10K device interface. For more details or information on other Altera applications, please reference the "AT17A Series Conversions from Altera FPGA Serial Configuration Memories" application note.

FPGA Device Configuration

FPGA devices can be configured with an AT17A Series EEPROM as shown in Figure 1. The AT17A Series device stores configuration data in its EEPROM array and clocks the data out serially with its internal oscillator. The OE, nCS, and DCLK pins supply the control signals for the address counter and the output tri-state buffer. The AT17A Series device sends a serial bitstream of configuration data to its DATA pin, which is connected to the DATA0 input pin on the FPGA device.

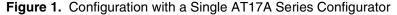
When configuration data for an FPGA device exceeds the capacity of a single AT17A Series device, multiple AT17A Series devices can be serially linked together (Figure 2). When multiple AT17A Series devices are required, the nCASC and nCS pins provide handshaking between the cascaded EEPROMs.

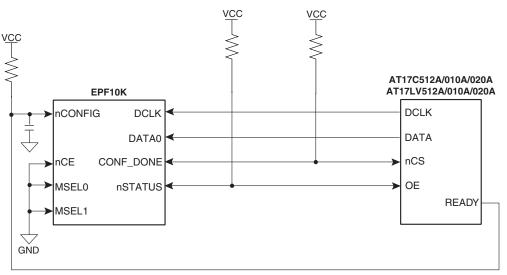
The position of an AT17A Series device in a chain determines its operation. The first AT17A Series device in a Configurator chain is powered up or reset with nCS Low and is configured for the FPGA device's protocol. This AT17A Series device supplies all clock pulses to one or more FPGA devices and to any downstream AT17A Series Configurator during configuration. The first AT17A Series Configurator also provides the first stream of data to the FPGA devices during multi-device configuration. Once the

first AT17A Series device finishes sending configuration data, it drives its nCASC pin Low, which drives the nCS pin of the second AT17A Series device Low. This activates the second AT17A Series device to send configuration data to the FPGA device.

The first AT17A Series device clocks all subsequent AT17A Series devices until configuration is complete. Once all configuration data is transferred and nCS on the first AT17A Series device is driven High by CONF_DONE on the FPGA devices, the first AT17A Series device clocks 16 additional cycles to initialize the FPGA device before going into zero-power (idle) state. If nCS on the first AT17A Series device is driven High before all configuration data is transferred – or if the nCS is not driven High after all configuration data is transferred – nSTATUS is driven Low, indicating a configuration error.

The READY pin is available as an open-collector indicator of the device's reset status; it is driven Low while the device is in its power-on reset cycle and released (tri-stated) when the cycle is complete. It can be used to hold the FPGA device in reset while it is completing its power-on reset but it cannot be used to effectively delay configuration (i.e., the output is released well before the system $V_{\rm CC}$ has stabilized).





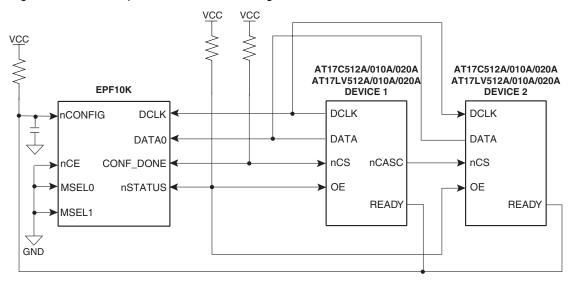
Notes: 1. $1.0 \text{ k}\Omega$ resistors used unless otherwise specified.

- 2. Applicable to EPF6K.
- 3. Use of the READY pin is optional.
- Introducing a RC delay to the input of nCONFIG is recommended to ensure that V_{CC} (5V/3.3V) is reached before configuration begins. (nCONFIG can instead be connected to an active Low system reset signal.)
- 5. Reset polarity of EEPROM must be set active Low (OE active High).





Figure 2. Configuration with Multiple AT17A Series Configurators



- Notes: 1. $1.0 \text{ k}\Omega$ resistors used unless otherwise specified.
 - 2. Use of the READY pin is optional.
 - 3. Introducing a RC delay to the input of nCONFIG is recommended to ensure that V_{CC} (5V/3.3V) is reached before configuration begins. (nCONFIG can instead be connected to an active Low system reset signal.)
 - 4. Reset polarity of EEPROM must be set active Low (OE active High).

AT17A Series Reset Polarity

The AT17A Series Configurator allows the user to program the polarity of the OE pin as either RESET/OE or RESET/OE. For more details, please reference the "Programming Specification for Atmel's FPGA Configuration EEPROMs" application note.

Programming Mode

The programming mode is entered by bringing SER_EN Low. In this mode the chip can be programmed by the 2-wire serial interface. The programming is done at V_{CC} supply only. Programming super voltages are generated inside the chip. See the "Programming Specification for Atmel's Configuration EEPROMs" application note for further information. The AT17 A-series parts are read/write at 5V nominal. The AT17LV A-series parts are read/write at 3.3V nominal.

Standby Mode

The AT17A Series Configurator enters a low-power standby mode whenever nCS is asserted High. In this mode, the configuration consumes less than 0.5 mA of current at 5V. The output remains in a high-impedance state regardless of the state of the OE input.

Pin Configurations

20 PLCC Pin	Nama		
FIII	Name	I/O	Description
2	DATA	I/O	Three-state data output for configuration. Open-collector bi-directional pin for programming.
4	DCLK	I/O	Clock output or clock input. Rising edges on DCLK increment the internal address counter and present the next bit of data to the DATA pin. The counter is incremented only if the OE input is held High, the nCS input is held Low, and all configuration data has not been transferred to the target device (otherwise, as the master device, the DCLK pin drives Low).
8	OE	I	Output enable (active High) and reset (active Low) when SER_EN is High. A Low logic level resets the address counter. A High logic level (with nCS Low) enables DATA and permits the address counter to count. In the mode, if this pin is Low (reset), the internal oscillator becomes inactive and DCLK drives Low. The logic polarity of this input is programmable and must be programmed active High (RESET active Low) by the user during programming for Altera applications.
9	nCS	I	Chip select input (active Low). A Low input (with OE High) allows DCLK to increment the address counter and enables DATA to drive out. If the AT17A Series is reset with nCS Low, the device initializes as the first (and master) device in a daisy-chain. If the AT17A Series is reset with nCS High, the device initializes as a subsequent AT17A Series device in the chain.
10	GND		Ground pin. A 0.2 μF decoupling capacitor should be placed between the VCC and GND pins.
12	nCASC	0	Cascade select output (active Low). This output goes Low when the address counter has reached its maximum value. In a daisy-chain of AT17A Series devices, the nCASC pin of one device is usually connected to the nCS input pin of the next device in the chain, which permits DCLK from the master Configurator to clock data from a subsequent AT17A Series device in the chain.
	A2	1	Device selection input, A2. This is used to enable (or select) the device during programming, (i.e., when SER_EN is Low; please refer to the "Programming Specification" application note for more details).
15	READY	0	Open collector reset state indicator. Driven Low during power-up reset, released (tri-stated) when power-up is complete. (Recommend a 4.7 k Ω pull-up on this pin if used).
18	SER_EN	I	Serial enable must be held High during FPGA loading operations. Bringing SER_EN Low, enables the 2-wire serial programming mode.
20	VCC		+3.3V/+5V power supply pin

Absolute Maximum Ratings*

·
Operating Temperature55°C to +125°C
Storage Temperature65°C to +150°C
Voltage on Any Pin with Respect to Ground0.1V to V _{CC} +0.5V
Supply Voltage (V _{CC})0.5V to +7.0V
Maximum Soldering Temp. (10 sec @ 1/16 in.)260°C
ESD (R _{ZAP} = 1.5K, C _{ZAP} = 100 pF)2000V

*NOTICE:

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those listed under Operating Conditions is not implied. Exposure to Absolute Maximum Ratings conditions for extended periods of time may affect device reliability.





Operating Conditions

			AT17C020A	AT17LV020A	
Symbol	Description		Min/Max	Min/Max	Units
	Commercial	Supply voltage relative to GND -0°C to +70°C	4.75/5.25	3.15/3.45	V
V_{CC}	Industrial	Supply voltage relative to GND -40°C to +85°C	4.5/5.5	3.15/3.45	V
	Military	Supply voltage relative to GND -55°C to +125°C	4.5/5.5	3.15/3.45	V

■ AT17C/LV020A

DC Characteristics

 V_{CC} = 5V ± 5% Commercial / 5V ± 10% Ind./Mil.

Symbol	Description			Max	Units
V _{IH}	High-level input voltage		2.0	V _{CC}	V
V _{IL}	Low-level input voltage		0	0.8	V
V _{OH}	High-level output voltage (I _{OH} = -4 mA)	n-level output voltage (I _{OH} = -4 mA)			V
V _{OL}	Low-level output voltage (I _{OL} = +4 mA)	Commercial		0.32	V
V _{OH}	High-level output voltage (I _{OH} = -4 mA)	la di satri al	3.76		V
V _{OL}	Low-level output voltage (I _{OL} = +4 mA)	Industrial		0.37	V
V _{OH}	High-level output voltage (I _{OH} = -4 mA)	Military	3.7		V
V _{OL}	Low-level output voltage (I _{OL} = +4 mA)	Military		0.4	V
I _{CCA}	Supply current, active mode (at FMAX)			10	mA
IL	Input or output leakage current (V _{IN} = V _{CC} or GND)		-20	20	μA
1	Cupply average standby reads AT47C000A	Commercial		0.5	mA
I _{CCS}	Supply current, standby mode AT17C020A	Industrial/Military		0.75	mA

DC Characteristics

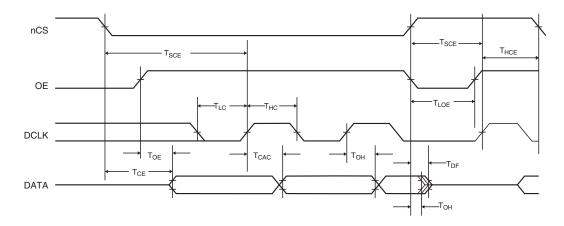
 $V_{CC} = 3.3V \pm 5\%$

Symbol	Description		Min	Max	Units
V _{IH}	High-level input voltage		2.0	V _{CC}	V
V _{IL}	Low-level input voltage			0.8	V
V _{OH}	High-level output voltage (I _{OH} = -2.5 mA)	High-level output voltage (I _{OH} = -2.5 mA)			V
V _{OL}	Low-level output voltage (I _{OL} = +3 mA)	Commercial		0.4	V
V _{OH}	High-level output voltage (I _{OH} = -2 mA)	la divadala l	2.4		V
V _{OL}	Low-level output voltage (I _{OL} = +3 mA)	Industrial		0.4	V
V _{OH}	High-level output voltage (I _{OH} = -2 mA)	NA:III	2.4		V
V _{OL}	Low-level output voltage (I _{OL} = +2.5 mA)	Military		0.4	V
I _{CCA}	Supply current, active mode (at FMAX)			5	mA
I _L	Input or output leakage current (V _{IN} = V _{CC} or GND)	Input or output leakage current (V _{IN} = V _{CC} or GND)		20	μΑ
I _{CCS}	Consider accordant standards and de	Commercial		200	μΑ
	Supply current, standby mode	Industrial/Military		200	μA

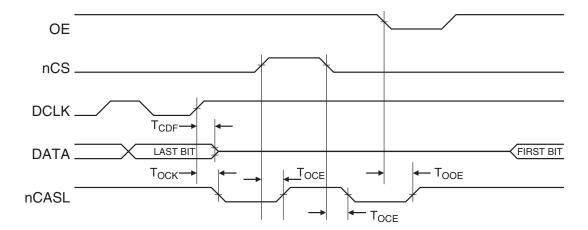




AC Characteristics



AC Characteristics When Cascading



AC Characteristics for AT17C020A

 V_{CC} = 5V \pm 5% Commercial / V_{CC} = 5V \pm 10% Ind./Mil

		Comr	nercial	Industrial/Military ⁽¹⁾		
Symbol	Description	Min	Max	Min	Max	Units
T _{OE} ⁽²⁾	OE to Data Delay		30		35	ns
T _{CE} ⁽²⁾	nCS to Data Delay		45		45	ns
T _{CAC} ⁽²⁾	DCLK to Data Delay		50		55	ns
T _{OH}	Data Hold From nCS, OE, or DCLK	0		0		ns
T _{DF} ⁽³⁾	nCS or OE to Data Float Delay		50		50	ns
T _{LC}	DCLK Low Time Slave Mode	20		20		ns
T _{HC}	DCLK High Time Slave Mode	20		20		ns
T _{SCE}	nCS Setup Time to DCLK (to guarantee proper counting)	20		25		ns
T _{HCE}	nCS Hold Time from DCLK (to guarantee proper counting)	0		0		ns
T _{LOE}	OE Low Time (guarantees counter is reset)	20		20		ns
F _{MAX}	MAX Input Clock Frequency Slave Mode	12.5		12.5		MHz
T _{LC}	DCLK Low Time Master Mode	30	250	30	250	ns
T _{HC}	DCLK High Time Master Mode	30	250	30	250	ns

AC Characteristics for AT17C020A When Cascading

 V_{CC} = 5V ± 5% Commercial / V_{CC} = 5V ± 10% Ind./Mil.

		Comn	nercial	Industrial	/Military ⁽¹⁾	
Symbol	Description	Min	Max	Min	Max	Units
T _{CDF} (3)	DCLK to Data Float Delay		50		50	ns
T _{OCK} ⁽²⁾	DCLK to nCASC Delay		35		40	ns
T _{OCE} ⁽²⁾	nCS to nCASC Delay		35		35	ns
T _{OOE} ⁽²⁾	OE to nCASC Delay		30		30	ns
F _{MAX}	MAX Input Clock Frequency	12.5		12.5		MHz

Notes: 1. Preliminary specifications for military operating range only.

- 2. AC test load = 50 pF.
- 3. Float delays are measured with 5 pF AC loads. Transition is measured ± 200 mV from steady state active levels.





AC Characteristics for AT17LV020A

 V_{CC} = 3.3V ± 5% Commercial / V_{CC} = 3.3V ± 5% Ind./Mil.

		Comn	nercial	Industrial	/Military ⁽¹⁾	
Symbol	Description	Min	Max	Min	Max	Units
T _{OE} ⁽²⁾	OE to Data Delay		50		55	ns
T _{CE} ⁽²⁾	nCS to Data Delay		55		60	ns
T _{CAC} ⁽²⁾	DCLK to Data Delay		60		65	ns
T _{OH}	Data Hold From nCS, OE, or DCLK	0		0		ns
T _{DF} ⁽³⁾	nCS or OE to Data Float Delay		50		50	ns
T _{LC}	DCLK Low Time Slave Mode	25		25		ns
T _{HC}	DCLK High Time Slave Mode	25		25		ns
T _{SCE}	nCS Setup Time to DCLK (to guarantee proper counting)	35		40		ns
T _{HCE}	nCS Hold Time from DCLK (to guarantee proper counting)	0		0		ns
T _{LOE}	OE Low Time (guarantees counter is reset)	20		20		ns
F _{MAX}	MAX Input Clock Frequency Slave Mode	12		7.5		MHz
T _{LC}	DCLK Low Time Master Mode	30	300	30	300	ns
T _{HC}	DCLK High Time Master Mode	30	300	30	300	ns

AC Characteristics for AT17LV020A When Cascading

 V_{CC} = 3.3V ± 5% Commercial / V_{CC} = 3.3V ± 5% Ind./Mil.

		Commercial		Industrial/Military(1)			
Symbol	Description	Min	Max	Min	Max	Units	
T _{CDF} ⁽³⁾	DCLK to Data Float Delay		50		50	ns	
T _{OCK} ⁽²⁾	DCLK to nCASC Delay		50		55	ns	
T _{OCE} ⁽²⁾	nCS to nCASC Delay		35		40	ns	
T _{OOE} ⁽²⁾	OE to nCASC Delay		35		35	ns	
F _{MAX}	MAX Input Clock Frequency Slave Mode	12		7.5		MHz	

Notes: 1. Preliminary specifications for military operating range only.

- 2. AC test load = 50 pF.
- 3. Float delays are measured with 5 pF AC loads. Transition is measured ±200 mV from steady state active levels.

Ordering Information - 5V Devices

Memory Size	Ordering Code	Package	Operation Range
2M ⁽¹⁾	AT17C020A-10JC	20J	Commercial (0°C to 70°C)
	AT17C020A-10JI	20J	Industrial (-40°C to 85°C)

Ordering Information - 3.3V Devices

Memory Size	Ordering Code	Package	Operation Range
2M ⁽¹⁾	AT17LV020A-10JC	20J	Commercial (0°C to 70°C)
	AT17LV020A-10JI	20J	Industrial (-40°C to 85°C)

Note: 1. Use 2M density parts to replace Altera EPC2.

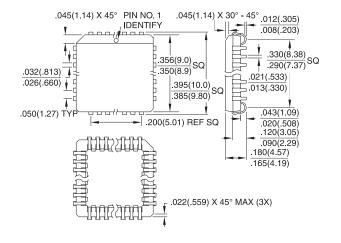
Package Type			
20J	20-lead, Plastic J-leaded Chip Carrier (PLCC)		





Packaging Information

20J, 20-lead, Plastic J-leaded Chip Carrier (PLCC) Dimensions in Inches and (Millimeters) JEDEC STANDARD MS-018 AA





Atmel Headquarters

Corporate Headquarters 2325 Orchard Parkway San Jose, CA 95131 TEL (408) 441-0311 FAX (408) 487-2600

Europe

Atmel U.K., Ltd.
Coliseum Business Centre
Riverside Way
Camberley, Surrey GU15 3YL
England
TEL (44) 1276-686-677
FAX (44) 1276-686-697

Asia

Atmel Asia, Ltd. Room 1219 Chinachem Golden Plaza 77 Mody Road Tsimhatsui East Kowloon Hong Kong TEL (852) 2721-9778 FAX (852) 2722-1369

Iapan

Atmel Japan K.K. 9F, Tonetsu Shinkawa Bldg. 1-24-8 Shinkawa Chuo-ku, Tokyo 104-0033 Japan TEL (81) 3-3523-3551 FAX (81) 3-3523-7581

Atmel Operations

Atmel Colorado Springs 1150 E. Cheyenne Mtn. Blvd. Colorado Springs, CO 80906 TEL (719) 576-3300 FAX (719) 540-1759

Atmel Rousset
Zone Industrielle
13106 Rousset Cedex
France
TEL (33) 4-4253-6000
FAX (33) 4-4253-6001

Application Support Hotline: 1-(408) 436-4119

e-mail: configurator@atmel.com

FAQ:

Accessible from Web Site

Fax-on-Demand North America: 1-(800) 292-8635 International: 1-(408) 441-0732

e-mail literature@atmel.com

Web Site http://www.atmel.com

BBS 1-(408) 436-4309

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